IRF510

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{gs} (nC)

Q_{gd} (nC)

Q_a max. (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

0.54

100

8.3

2.3

3.8

Single

 $V_{GS} = 10 V$

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRF510PbF			
Lead (Pb)-free and halogen-free	IRF510PbF-BE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwite PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	100	- V	
Gate-source voltage			V _{GS}	± 20		
Continuous dusin suurant	N	T _C = 25 °C	- I _D	5.6		
Continuous drain current	V _{GS} at 10 V	T _C = 100 °C		4.0	А	
Pulsed drain current ^a			I _{DM}	20		
Linear derating factor				0.29	W/°C	
Single pulse avalanche energy ^b			E _{AS}	75	mJ	
Repetitive avalanche current ^a			I _{AR}	5.6	А	
Repetitive avalanche energy ^a			E _{AR}	4.3	mJ	
Maximum power dissipation	T _C = 25 °C		P _D	43	W	
Peak diode recovery dV/dt ^c			dV/dt	5.5	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +175	**	
Soldering recommendations (peak temperature) ^d	For 10 s		-	300	- °C	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting torque				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 4.8 mH, $R_g = 25 \Omega$, $I_{AS} = 5.6 \text{ A}$ (see fig. 12)

c. $I_{SD} \le 5.6$ A, dl/dt ≤ 75 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	62		
Case-to-sink, flat, greased surface	R _{thCS}	0.50	-	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	3.5		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•	•	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	0 V, I _D = 250 μA	100	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = 1 mA	-	0.12	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = V	V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-source leakage	I _{GSS}	V	_{GS} = ± 20 V	-	-	± 100	nA
Zerrente aller della sural	-	$V_{DS} = T$	100 V, V _{GS} = 0 V	-	-	25	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 80 V, V	/ _{GS} = 0 V, T _J = 150 °C	-	-	250	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D =3.4 A ^b	-	-	0.54	Ω
Forward transconductance	9 _{fs}	$V_{DS} = \xi$	50 V, I _D = 3.4 A ^b	1.3	-	-	S
Dynamic		•			•	•	
Input capacitance	C _{iss}		$V_{GS} = 0 V,$	-	180	-	
Output capacitance	C _{oss}	V	$V_{\rm DS} = 25 \rm V,$	-	81	-	pF
Reverse transfer capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	15	-	1
Total gate charge	Qg		I _D = 5.6 A, V _{DS} = 80 V	-	-	8.3	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	V _{DS} = 10 V,	-	-	2.3	nC
Gate-drain charge	Q _{gd}	-	see fig. 6 and fig. 13 ^b	-	-	3.8	
Turn-on delay time	t _{d(on)}			-	6.9	-	
Rise time	t _r	V _{DD} =	50 V, I _D = 5.6 A	-	16	-	
Turn-off delay time	t _{d(off)}	$R_g = 24 \Omega, R_D = 8.4 \Omega, \text{ see fig. 10 b}$		-	15	-	ns
Fall time	t _f			-	9.4	-	
Gate input resistance	Rg	f = 1 MHz, open drain		2.5	-	11.6	Ω
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	
Internal source inductance	L _S			-	7.5	-	nH
Drain-Source Body Diode Characteristi	cs						
Continuous source-drain diode current	I _S	MOSFET syr showing th	ne 🛛 🗖	-	-	5.6	A
Pulsed diode forward current ^a	I _{SM}	integral reverse p - n junction diode		-	-	20	
Body diode voltage	V _{SD}	T _J = 25 °C,	$_{\rm S}$ = 5.6 A, V _{GS} = 0 V ^b	-	-	2.5	V
Body diode reverse recovery time	t _{rr}	T ₁ = 25 °C I= =	5.6 A, dl/dt = 100 A/µs ^b	-	100	200	ns
Body diode reverse recovery charge	Q _{rr}	$r_{\rm J} = 23$ 0, $r_{\rm F} =$	ο.ο Α, αι/αι – 100 Α/μο	-	0.44	0.88	μC
Forward turn-on time	t _{on}	Intrinsic tur	n-on time is negligible (turi	n-on is do	minated	by L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

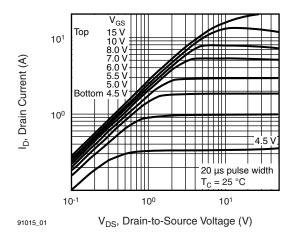


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

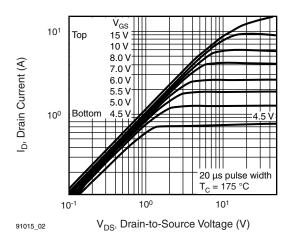
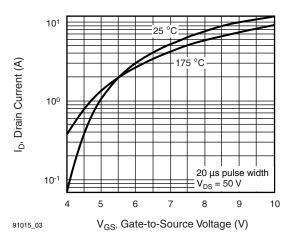


Fig. 2 - Typical Output Characteristics, $T_C = 175 \ ^{\circ}C$





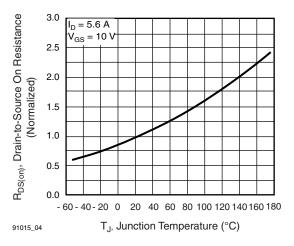


Fig. 4 - Normalized On-Resistance vs. Temperature

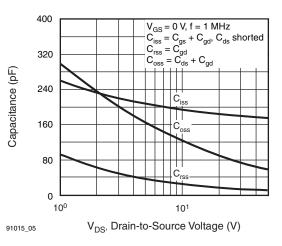


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

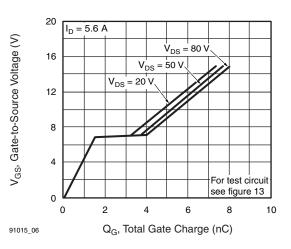


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

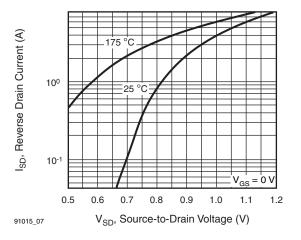
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Fig. 7 - Typical Source-Drain Diode Forward Voltage

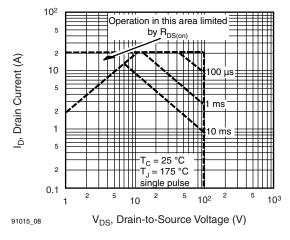


Fig. 8 - Maximum Safe Operating Area

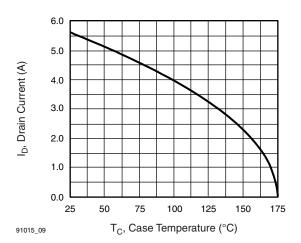


Fig. 9 - Maximum Drain Current vs. Case Temperature

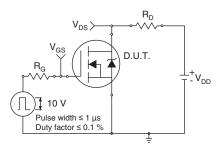


Fig. 10a - Switching Time Test Circuit

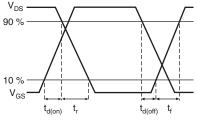
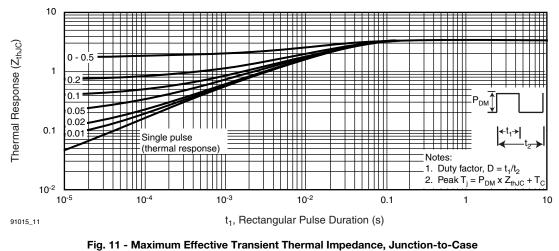


Fig. 10b - Switching Time Waveforms



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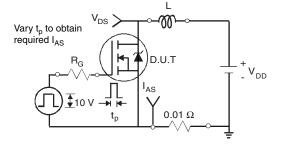


Fig. 12a - Unclamped Inductive Test Circuit

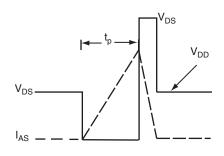


Fig. 12b - Unclamped Inductive Waveforms

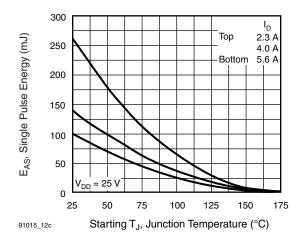


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

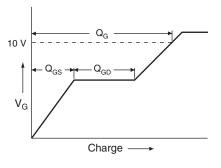


Fig. 13a - Basic Gate Charge Waveform

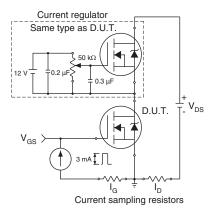
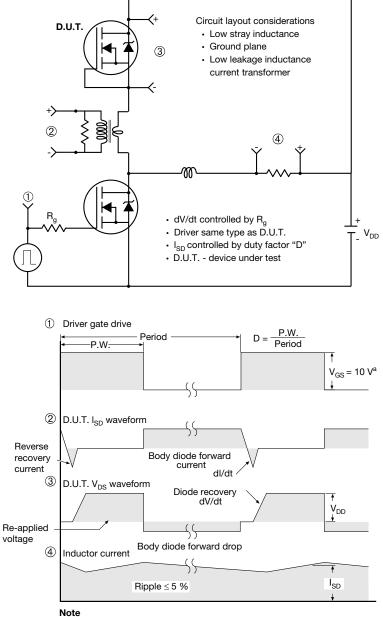


Fig. 13b - Gate Charge Test Circuit





Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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